

USB400A - PRELIMINARY

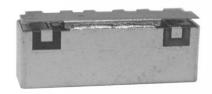
3800-4200MHz USB Series TDD Bandpass Filter

Features

- Low Loss with High Rejection and Low Ripple
- Support for 3GPP Receive Blocker specification
- Universal footprint across family for all TDD bands

Applications

- Wireless Infrastructure applications
- High-performance carrier-grade single-band TDD Pico-cell basestations for up to 5.0W at the antenna port.



Part Dimensions: $25.7 \times 4.8 \times 6.6$ mm • 2.5 g Materials: Ag plated ceramic block with tin plated brass shield

Description

Surface mount ceramic bandpass filter supports a universal footprint across all TDD frequency bands enabling the use of a common system PCB. Superior rejection, insertion loss, reliability, as well as both peak and average power handling compared to other bandpass filter technologies.

Electrical Specifications

Parameter	Frequency (MHz)	Typical at 25℃	Spec. at 25°C	Spec. over -40°C to +85°C
Nominal Impedance	-	50 ohms	-	-
Average Input Power	-	-	-	8.0 Watt max
Peak Input Power	-	-	-	80 Watt max
Input-Output Response				
Passband Insertion Loss (5 MHz avg)	3800-4200	1.2 dB	1.5 dB max	1.7 dB max
Passband Ripple (20MHz)	3800-4200	0.8 dB	1.1 dB max	1.2 dB max
Passband Return Loss	3800-4200	14 dB	12 dB min	12 dB min
Attenuation:	1-2690	45 dB	42 dB min	42 dB min
	2691-3400	40 dB	38 dB min	38 dB min
	3401-3740	18 dB	15 dB min	15 dB min
	4260-4599	18 dB	15 dB min	15 dB min
	4600-4799	43 dB	38 dB min	38 dB min
	4800-TBD	45 dB	42 dB min	42 dB min

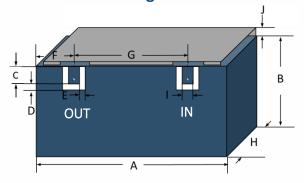
Note: CTS tests each unit to the critical specifications above. Subsequent audits may deviate due to repeatability among different test systems which shall not exceed these allowances. Specification Allowance
Insertion Loss 0.1 dB
Return Loss 1.0 dB
Attenuation 1.0 dB

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Mechanical Drawing

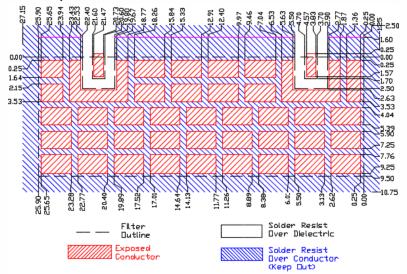


PCB Layout

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44.0 mm

5.30 mm



Nominal Tolerance Dim. (±mm or Max) (mm) Α 25.40 0.30 В 3.40 0.30 C 1.70 0.13 D 0.80 0.13 Ε 0.80 0.13 F 4.20 0.13 G 16.90 0.13 Н 6.40 0.20 1 1.00 0.13 J 0.90 0.20

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IMPORTANT: Please assure >= 20 mils (0.5mm) thickness of dielectric beneath the I/O Pads and surrounding clearance zone to the required ground plane.

NOTE: The width of 9.50mm is necessary to support frequencies as low as 1885MHz for Band 39. If only higher frequency TDD bands are supported, then a smaller space can be allocated on the layout.

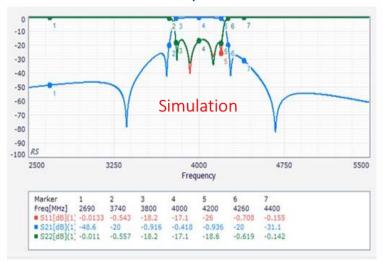
Packaging and Marking

	Dimens	ion Ur	nts Spe	ec. Prod	luct Marking				
	Reel Diam	ieter m	m 33	0	CTS				
	Reel Wei	ght k	g 5.	5	400				
	Reel Quar	ntity e	a. 50	0	YWW				
	Customer Feed Direction $ ightarrow ightarrow ightarrow ightarrow$								
	Po	ф ф		Wo MM/(Inches)	Bo MM/(Inel				
	MM/(Inches)	-	+ I+	Ao	MM/(Inches)				
MDi/(Inches)									
	W_{o}	Ao	Во	Ko	Po				
	1.732 in	0.209 in	1.028	3 in 0.283	3 in 0.472 in				

26.10 mm

7.20 mm

Electrical Response



12.0 mm